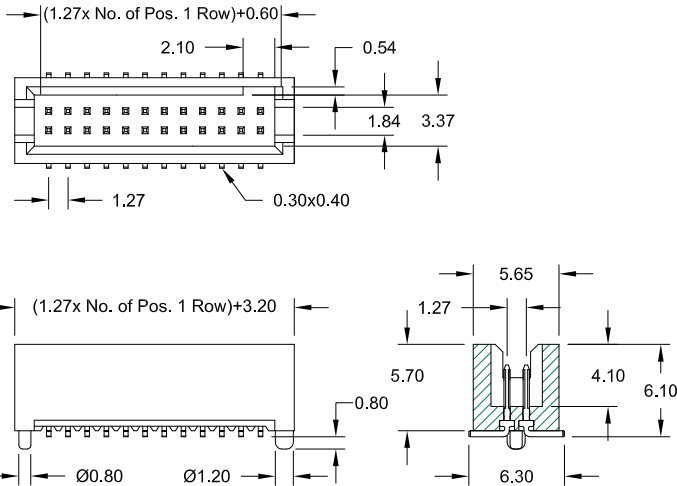
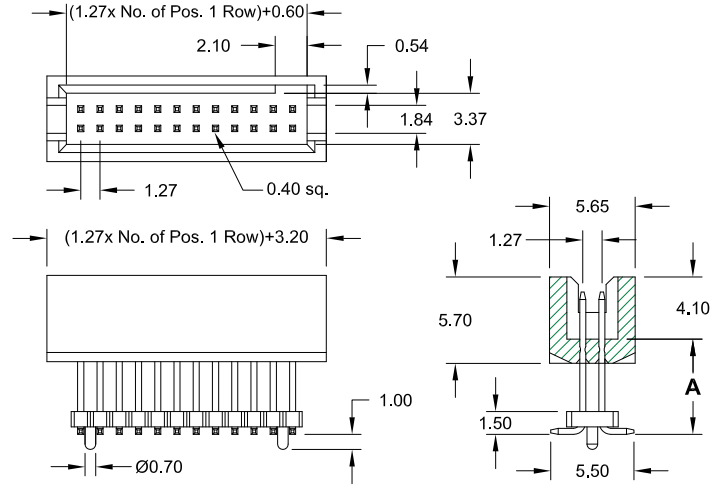
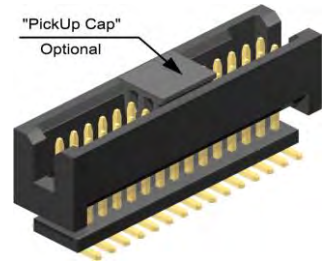


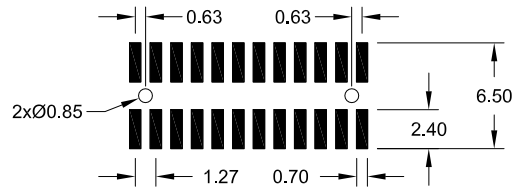
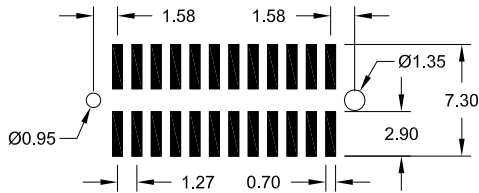
Style **H610**



Style **HPxx**



PCB Surface Mount Layout



Specifications

Current rating	1 A	Operating temperature	- 40°C to +105°C
Insulation resistance	1000 MΩ min.	Processing temperature	+250°C +0/-5°C for 5sec.
Contact resistance	20 mΩ max.	Contact material	(RoHS compliant) Phosphor Bronze
Withstanding voltage	300 V AC	Insulator material	(RoHS compliant) LCP UL 94 V-0

Application and Features

Mating with 1.27mm pitch Female Headers BS2-xxx-H45B- & -H45P-55/11 (page 33) as "board to board" connection.

No ejection latches for space saving.

How to order

SLS - xxx - Xxxx - 55/11 X

Nbr of pins	Style	Plating	Packing Option	
010 to 100	H610 Low Profile	55 = Gold other platings on request	D = Tube packing; with "PickUp Cap" E = Reel packing; with "PickUp Cap"	
	Raised Type			DIM "A"
	HP20			15.00 mm (standard)
	HP21			18.00 mm
	HP22			8.50 mm
	other dimensions on request			